

Dual N-channel MOSFET

ELM14816AA-N

■ General description

ELM14816AA-N uses advanced trench technology to provide excellent R_{d(on)} and low gate charge.

■ Features

- V_{ds}=30V
- I_d=8.5A
- R_{d(on)} < 17mΩ (V_{gs}=20V)
- R_{d(on)} < 20mΩ (V_{gs}=10V)
- R_{d(on)} < 46mΩ (V_{gs}=4.5V)

■ Maximum absolute ratings

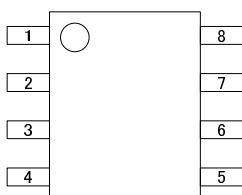
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	V _{ds}	30	V	
Gate-source voltage	V _{gs}	±25	V	
Continuous drain current	I _d	8.5	A	1
		6.5		
Pulsed drain current	I _{dm}	40	A	2
Power dissipation	P _d	2.00	W	
		1.28		
Junction and storage temperature range	T _j , T _{stg}	-55 to 150	°C	

■ Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	t≤10s	R _{θja}	48.0	62.5	°C/W	1
Maximum junction-to-ambient	Steady-state		74.0	110.0	°C/W	
Maximum junction-to-lead	Steady-state	R _{θjl}	33.0	40.0	°C/W	3

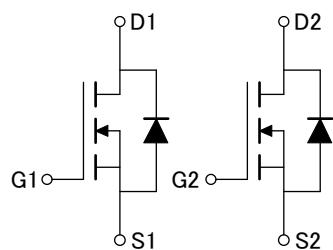
■ Pin configuration

SOP-8 (TOP VIEW)



Pin No.	Pin name
1	SOURCE2
2	GATE2
3	SOURCE1
4	GATE1
5	DRAIN1
6	DRAIN1
7	DRAIN2
8	DRAIN2

■ Circuit



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■ Electrical characteristics

$T_a=25^\circ C$

Parameter	Symbol	Condition		Min.	Typ.	Max.	Unit
STATIC PARAMETERS							
Drain-source breakdown voltage	BVdss	Id=250 μA , Vgs=0V		30			V
Zero gate voltage drain current	Idss	Vds=24V				1	μA
		Vgs=0V	Tj=55°C			5	
Gate-body leakage current	Igss	Vds=0V, Vgs=±25V				100	nA
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=250 μA		1.5	2.4	3.0	V
On state drain current	Id(on)	Vgs=10V, Vds=5V		30			A
Static drain-source on-resistance	Rds(on)	Vgs=20V			13.5	17.0	$m\Omega$
		Id=8.5A	Tj=125°C		17.5	22.0	
		Vgs=10V, Id=8.5A			16.0	20.0	$m\Omega$
		Vgs=4.5V, Id=5A			36.0	46.0	$m\Omega$
Forward transconductance	Gfs	Vds=5V, Id=10A		10	17		S
Diode forward voltage	Vsd	Is=1A, Vgs=0V			0.76	1.00	V
Max. body-diode continuous current	Is					4.3	A
DYNAMIC PARAMETERS							
Input capacitance	Ciss	Vgs=0V, Vds=15V, f=1MHz			758		pF
Output capacitance	Coss				180		pF
Reverse transfer capacitance	Crss				128		pF
Gate resistance	Rg	Vgs=0V, Vds=0V, f=1MHz			0.7		Ω
SWITCHING PARAMETERS							
Total gate charge (10V)	Qg	Vgs=10V, Vds=15V, Id=8.5A			16.5		nC
Total gate charge (4.5V)	Qg				8.6		nC
Gate-source charge	Qgs				2.5		nC
Gate-drain charge	Qgd				4.8		nC
Turn-on delay time	td(on)	Vgs=10V, Vds=15V Rl=1.8 Ω , Rgen=3 Ω			5.4		ns
Turn-on rise time	tr				5.1		ns
Turn-off delay time	td(off)				14.4		ns
Turn-off fall time	tf				3.7		ns
Body diode reverse recovery time	trr	If=8.5A, dl/dt=100A/ μs			16.9		ns
Body diode reverse recovery charge	Qrr	If=8.5A, dl/dt=100A/ μs			6.6		nC

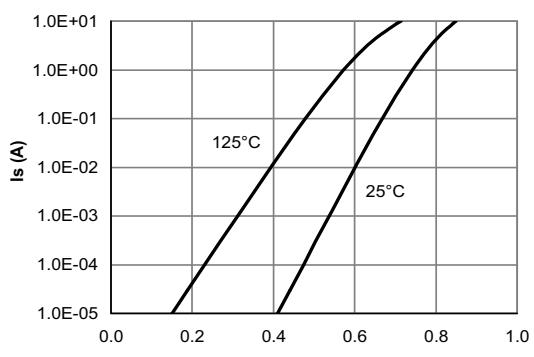
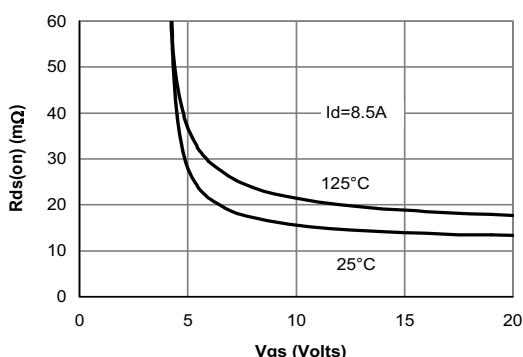
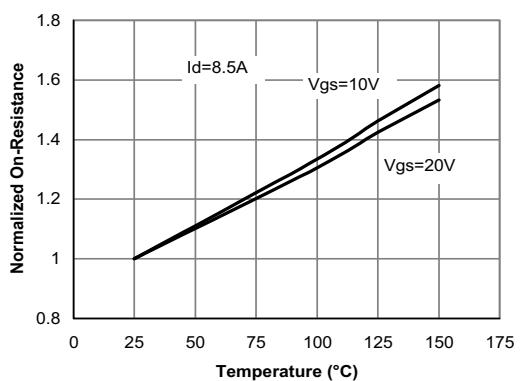
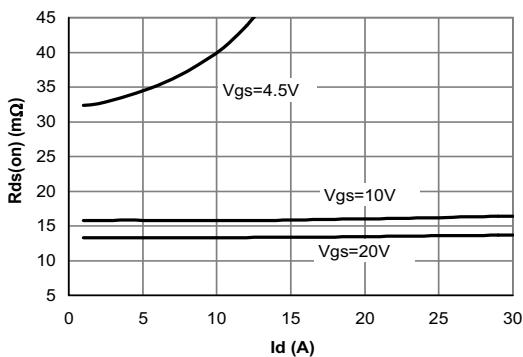
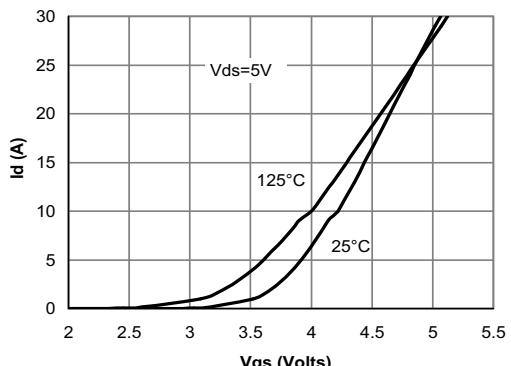
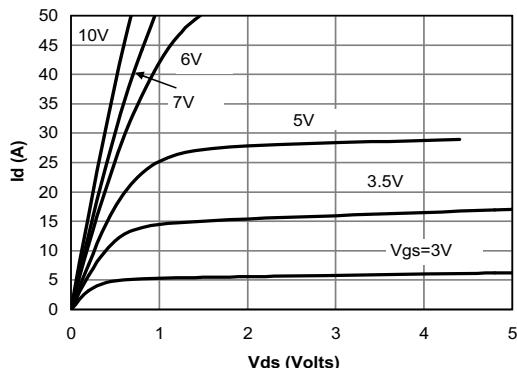
NOTE :

1. The value of $R_{\theta ja}$ is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with $T_a=25^\circ C$. The value in any given applications depends on the user's specific board design, The current rating is based on the $t \leq 10s$ thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The $R_{\theta ja}$ is the sum of the thermal impedance from junction to lead $R_{\theta jl}$ and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80 μs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_a=25^\circ C$. The SOA curve provides a single pulse rating.

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■ Typical electrical and thermal characteristics



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